

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): PRASHER	Confirmation No.: 2876
Application No.: 10/811,597	Docket No.: P18285
Filed: March 29, 2004	Group Art Unit: 2841
Title: COOLING AN INTEGRATED CIRCUIT DIE WITH COOLANT FLOW IN A MICROCHANNEL AND A THIN FILM THERMOELECTRIC COOLING DEVICE IN THE MICROCHANNEL	Examiner: Tuan T. Dinh PTO Customer Number 28062

Mail Stop Issue Fee (via EFS)

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

TRANSMITTAL LETTER

Sir:

Applicant hereby submits the following document(s) for the above-identified patent application:

1. Part B – Fee Transmittal.
2. Credit Card Authorization Payment for **\$1810.00** is paid through EFS.

Respectfully submitted,

November 2, 2009
Date

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